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User's Manual

IE-789831-NS-EM1

Emulation Board

Target Devices μPD789830 Subseries

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Major Revisions in This Edition

Page	Description			
Throughout	 Addition of IE-78K0S-NS-A as supported in-circuit emulator Addition of NP-H100GC-TQ as supported emulation probe 			
pp. 12, 13	Figure 1-1 System ConfigurationModification of shape of interface cableModification of supply medium of the debugger to CD-ROMModification of Notes 1 to 3			
р. 13	Addition of Table 1-1 Correspondence Between Emulation Probe and Conversion Socket/Conversion Adapter			
p. 15	Partial modification of Table 1-2 Basic Specifications			
p. 20	3.2 Switch and Jumper Settings on Main Unit • Addition of (2) Settings on the IE-78K0S-NS-A			
p. 23 of previous edition	Deletion of 3.3 Low-Voltage Emulation Setting			
p. 21	Addition of 3.3 Setting Power Supply Voltage of Target Interface			
pp. 22 to 25	 3.4.1 Overview of clock settings Change from "internal clock" in previous edition to "clock oscillator" Figure 3-3 External Circuits Used as System Clock Oscillator Addition of Vss pin in figure of (a) Clock oscillator Figure 3-4 When Using Clock That Is Already Mounted on Emulation Board (Main System Clock) to Figure 3-7 When Using User-Mounted Clock (Subsystem Clock) Change from "resonator" in previous revision to "clock oscillator or external clock" on target system Change from "clock generator" in previous edition to "external clock" in Figure 3-8 When Supplying Pulse from Target System 			
pp. 39, 40	Addition of APPENDIX B NOTES ON DESIGNING TARGET SYSTEM			

The mark \star shows major revised points.

INTRODUCTION

Product Overview The IE-789831-NS-EM1 is designed to be used with the IE-78K0S-NS or IE-78K0S-NS-A to debug the following target devices that belong to the 78K/0S Series of 8-bit single-chip microcontrollers.

• μPD789830 Subseries: μPD789830, 78F9831

Target ReadersThis manual is intended for engineers who will use the IE-789831-NS-EM1 with the IE-
78K0S-NS or IE-78K0S-NS-A to perform system debugging.Engineers who use this manual are expected to be thoroughly familiar with the target
device's functions and use methods and to be knowledgeable about debugging.

Organization When using the IE-789831-NS-EM1, refer to not only this manual (supplied with the IE-789831-NS-EM1) but also the manual that is supplied with the IE-78K0S-NS or IE-78K0S-NS-A.

IE-78K0S-NS User's Manual

- Basic specifications
- System configuration
- External interface functions

IE-78K0S-NS-A User's Manual

- Basic specifications
- System configuration
- External interface functions

Purpose

This manual's purpose is to explain various debugging functions that can be performed when using the IE-789831-NS-EM1.

IE-789831-NS-EM1 User's Manual

- General
- Part names
- Installation
- Differences between target devices and target interface circuits

Terminology

The meanings of certain terms used in this manual are listed below.

Term	Meaning		
Emulation device	This is a general term that refers to the device in the emulator that is used to emulate the target device. It includes the emulation CPU.		
Emulation CPU	This is the CPU block in the emulator that is used to execute user-generated programs.		
Target device	is is the device to be emulated.		
Target system	his includes the target program and the hardware provided by the user. When defined narrowly, it includes only the hardware.		
IE system	This refers to the combination of the in-circuit emulator (IE-78K0S-NS or IE-78K0S-NS-A) and the emulation board (IE-789831-NS-EM1).		

ions	Data significance:	Higher digits on the left and lower digits on the right
	Note:	Footnote for item marked with Note in the text
	Caution:	Information requiring particular attention
	Remark:	Supplementary information

Related Documents The related documents (user's manuals) indicated in this publication may include preliminary versions. However, preliminary versions are not marked as such.

Document Name	Document Number
IE-78K0S-NS In-Circuit Emulator	U13549E
IE-78K0S-NS-A In-Circuit Emulator	U15207E
IE-789831-NS-EM1 Emulation Board	This manual
ID78K Series Integrated Debugger Ver. 2.30 or Later Operation Windows™ Based	U15185E
μPD789830 Subseries	U13679E

Caution The documents listed above are subject to change without notice. Be sure to use the latest documents when designing.

CONTENTS

	CHAPT		-	
	1.1	Syste	m Configuration	12
	1.2	Hardv	vare Configuration	14
	1.3	Basic	Specifications	15
	СНАРТ	ER 2	PART NAMES	16
	2.1	Parts	of Main Unit	17
	СНАРТ	ER 3	INSTALLATION	18
	3.1	Conn	ection	19
	3.2	Switc	h and Jumper Settings on Main Unit	20
*	3.3	Settin	g Power Supply Voltage of Target Interface	21
	3.4	Clock	Settings	22
		3.4.1	Overview of clock settings	
		3.4.2	Main system clock settings	25
		3.4.3	Subsystem clock setting	
	3.5	Exter	nal Trigger	32
	СНАРТ	ER 4	DIFFERENCES BETWEEN TARGET DEVICE AND TARGET INTERF	ACE CIRCUIT33
	APPEN	DIX A	EMULATION PROBE PIN ASSIGNMENT TABLE	37
*	APPEN	DIX B	NOTES ON DESIGNING TARGET SYSTEM	39

LIST OF FIGURES

Figure	No. Title	Page
1-1	System Configuration	12
1-2	Basic Hardware Configuration	14
2-1	IE-789831-NS-EM1 Part Names	17
3-1	Connection of Emulation Probe	19
3-2	Connecting TP1 and Target System Power Supply Voltage	21
3-3	External Circuits Used as System Clock Oscillator	22
3-4	When Using Clock That Is Already Mounted on Emulation Board (Main System Clock)	23
3-5	When Using Clock That Is Already Mounted on Emulation Board (Subsystem Clock)	23
3-6	When Using User-Mounted Clock (Main System Clock)	24
3-7	When Using User-Mounted Clock (Subsystem Clock)	24
3-8	When Supplying Pulse from Target System	25
3-9	Connections on Parts Board (Main System Clock)	26
3-10	Crystal Oscillator (Main System Clock)	27
3-11	Pin Alignment of Crystal Oscillator and Socket (Main System Clock)	28
3-12	Connections on Parts Board (Subsystem Clock)	30
3-13	Crystal Oscillator (Subsystem Clock)	31
3-14	Pin Alignment of Crystal Oscillator and Socket (Subsystem Clock)	31
3-15	External Trigger Input Position	32
4-1	Equivalent Circuit of Emulation Circuit	35
B-1	Distance Between IE System and Conversion Adapter	
B-2	Connection Conditions of Target System (When NP-100GC Is Used)	40
B-3	Connection Conditions of Target System (When NP-H100GC-TQ Is Used)	40

LIST OF TABLES

Table	e No. Title	Page
1-1	Correspondence Between Emulation Probe and Conversion Adapter	
1-2	Basic Specifications	15
3-1	Switch and Jumper Settings on IE-78K0S-NS	
3-2	Switch and Jumper Settings on IE-78K0S-NS-A	
3-3	Setting Power Supply of Target Interface	
3-4	Main System Clock Settings	
3-5	Subsystem Clock Settings	
A-1	NP-100GC, NP-H100GC-TQ Pin Assignments	
B-1	Distance Between IE System and Conversion Adapter	

CHAPTER 1 GENERAL

The IE-789831-NS-EM1 is a development tool for efficient debugging of hardware or software when using one of the following target devices that belong to the 78K/0S Series of 8-bit single-chip microcontrollers. This chapter describes the IE-789831-NS-EM1's system configuration and basic specifications.

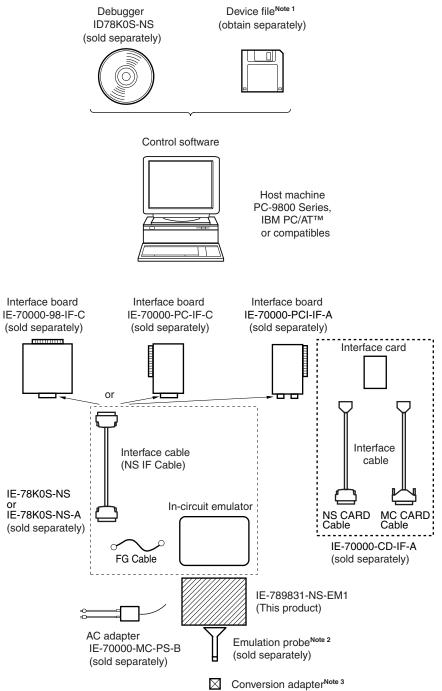
- Target devices
 - µPD789830 Subseries

Figure 1-1. System Configuration

1.1 System Configuration

Figure 1-1 illustrates the IE-789831-NS-EM1's system configuration.

*



(sold separately)

- **Notes 1.** The device file is as follows, in accordance with the subseries. μ S××××DF789831: μ PD789830, 78F9831 Subseries The device file can be downloaded from the web site of NEC Electronics (http://www.necel.com/micro/)
 - The emulation probes NP-100GC and NP-H100GC-TQ are products of Naito Densei Machida Mfg. Co., Ltd.

For further information, contact Naito Densei Machida Mfg. Co., Ltd. (TEL: +81-45-475-4191)

 The conversion adapter TGC-100SDW is a product of TOKYO ELETECH CORPORATION. For further information, contact Daimaru Kogyo Co., Ltd. Tokyo Electronics Department (TEL: +81-3-3820-7112) Osaka Electronics Department (TEL: +81-6-6244-6672)

*

Table 1-1. Correspondence Between Emulation Probe and Conversion Adapter

Package	Emulation Probe	Conversion Socket/Conversion Adapter
100-pin plastic LQFP	NP-100GC (probe length: 200 mm)	TGC-100SDW
(GC type)	NP-H100GC-TQ (probe length: 400 mm)	

1.2 Hardware Configuration

Figure 1-2 shows the IE-789831-NS-EM1's position in the basic hardware configuration.

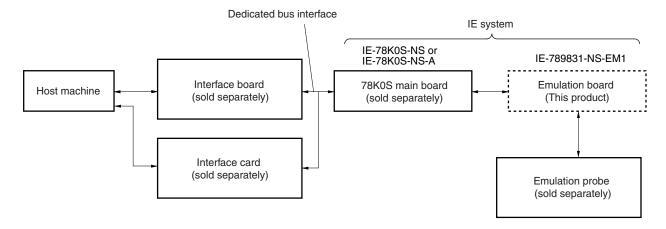


Figure 1-2. Basic Hardware Configuration

1.3 Basic Specifications

The basic specifications of the IE-789831-NS-EM1 are listed in Table 1-2.

Table 1-2. Basic Specifications

Parameter	Description	
Target device	μ PD789830 Subseries	
System clock	3.58 MHz	
Main system clock supply	External: Input via an emulation probe from the target system nternal: Mounted on emulation board (3.58 MHz), or mounted on the parts board by the user	
Subsystem clock supply	External: Input via an emulation probe from the target systemInternal: Mounted on the emulation board (32.768 kHz), or mounted on the parts board by the user	
Target interface voltage	V_{DD} = 2.7 to 5.0 V (same as that of target device) Operates on internal power supply (5 V) when target system is not connected	

CHAPTER 2 PART NAMES

This chapter introduces the parts of the IE-789831-NS-EM1 main unit.

The packing box contains the emulation board (IE-789831-NS-EM1), packing list, user's manual, and guarantee card.

If there are any missing or damaged items, please contact an NEC Electronics sales representative.

Fill out and return the guarantee card that comes with the main unit.

2.1 Parts of Main Unit

Figure 2-1 shows the part names of the IE-789831-NS-EM1.

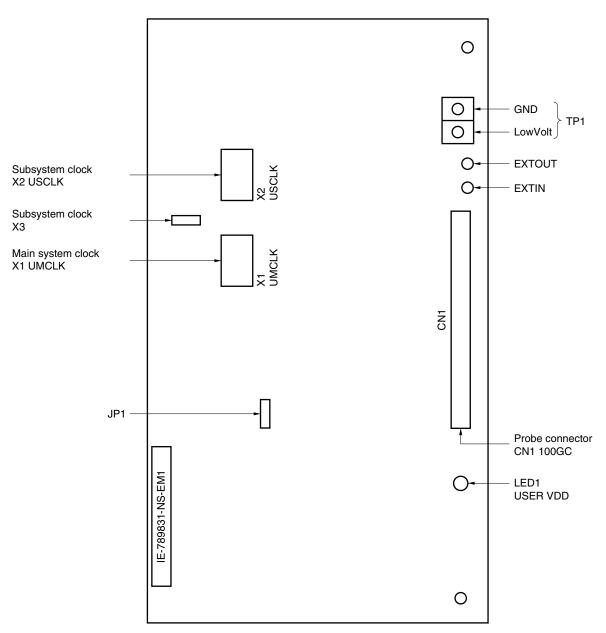


Figure 2-1. IE-789831-NS-EM1 Part Names

CHAPTER 3 INSTALLATION

This chapter describes methods for connecting the IE-789831-NS-EM1 to the IE-78K0S-NS or IE-78K0S-NS-A, emulation probe, etc. Mode setting methods are also described.

Caution Connecting or removing components to or from the target system, or making switch or other setting changes must be carried out after the power supply to both the IE system and the target system has been switched OFF.

3.1 Connection

(1) Connection with IE-78K0S-NS or IE-78K0S-NS-A main unit

See the **IE-78K0S-NS User's Manual (U13549E)** for a description of how to connect the IE-789831-NS-EM1 to the IE-78K0S-NS^{Note}.

Note When using the IE-78K0S-NS-A, see the IE-78K0S-NS-A User's Manual (U15207E).

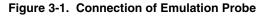
(2) Connection with emulation probe

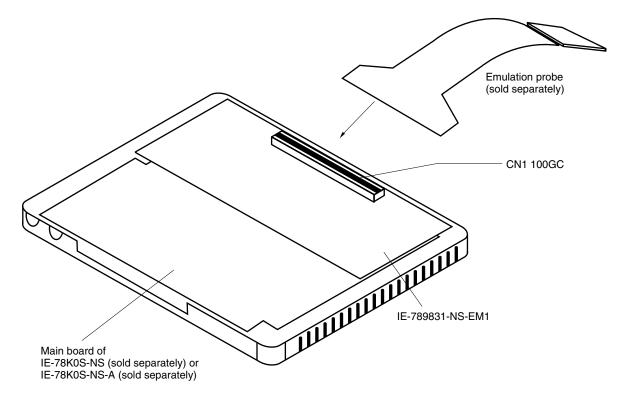
See the **IE-78K0S-NS User's Manual (U13549E)** for a description of how to connect an emulation probe to the IE-789831-NS-EM1^{Note}.

On this board, connect the emulation probe to CN1.

Note When using the IE-78K0S-NS-A, see the IE-78K0S-NS-A User's Manual (U15207E).

Caution Incorrect connection may damage the IE system. Be sure to read the emulation probe's user's manual for a detailed description of the connection method.





3.2 Switch and Jumper Settings on Main Unit

(1) Settings on the IE-78K0S-NS

When using the IE-789831-NS-EM1, set the switches and jumpers on the IE-78K0S-NS as shown in Table 3-1. For details of these switch and jumper settings, refer to the **IE-78K0S-NS User's Manual (U13549E)**.

Table 3-1. Switch and Jumper Settings on IE-78K0S-NS

	SW1	SW3	SW4	JP1	JP4
Setting	OFF	All switches ON (Fixed)	All switches ON (Fixed)	2 and 3 shorted	1 and 2 shorted

Caution Incorrect connection may damage the IE-789831-NS-EM1.

★ (2) Settings on the IE-78K0S-NS-A

When using the IE-789831-NS-EM1, set the switches and jumpers on the IE-78K0S-NS-A as shown in Table 3-2. For details of these switch and jumper settings, refer to the **IE-78K0S-NS-A User's Manual (U15207E)**.

Table 3-2. Switch and Jumper Settings on IE-78K0S-NS-A

	SW1	JP1	JP3
Setting	OFF	1 and 2 shorted (fixed)	Shorted (fixed)

Caution Incorrect connection may damage the IE-789831-NS-EM1.

3.3 Setting Power Supply Voltage of Target Interface

*

In the IE system, emulation is possible with a voltage of the same level as the power supply voltage of the target system.

When the target system is not connected, the IE system automatically operates with the emulator's internal power supply (5 V).

When debugging with a voltage that is the same level as that of the target system, supply the same voltage as that of the target system to the TP1 terminal pin of the IE-789831-NS-EM1 (the same applies when the voltage is 5 V). Set the target voltage to between 2.7 and 5.0 V.

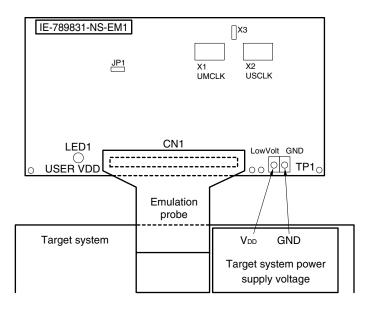
For how to select the operating power supply, refer to the **ID78K Series Ver.2.30 or Later Operation Windows-Based User's Manual (U15185E)**.

Maximum current consumption of TP1
 2.7 to 5.0 V: Approximately 100 mA

Power Supply of Target Interfac	Integrated Debugger (ID78K0S-NS)	
	Operating Power Supply Selection	
When connecting target system	2.7 to 5.0 V	Target
When not connecting target system	5 V	Internal



Figure 3-2. Connecting TP1 and Target System Power Supply Voltage	Figure 3-2.	Connecting TF	1 and Target System	Power Supply Voltage
---	-------------	----------------------	---------------------	-----------------------------



Caution Before connecting TP1 on the board and the target system power supply voltage, turn off the power to the IE-78K0S-NS or IE-78K0S-NS-A.

Remark The V_{DD} pin on the target system is exclusively used to control LED1 (USER VDD) that monitors whether the power supply of the target system is connected in the IE-789831-NS-EM1.

3.4 Clock Settings

3.4.1 Overview of clock settings

The main system clock and subsystem clock to be used during debugging can be selected from (1) to (3) below.

- (1) Clock that is already mounted on emulation board
- (2) Clock that is mounted by user
- (3) Pulse input from target system

If the target system includes a clock oscillator, select either (1) Clock that is already mounted on emulation board or (2) Clock that is mounted by user. For the clock oscillator, a resonator is connected to the target device and the target device's internal oscillator is used. An example of the external circuit is shown in part (a) of Figure 3-3. During emulation, the oscillator that is mounted on the target system is not used. Instead, the clock that is mounted on the emulation board installed in the IE-78K0S-NS or IE-78K0S-NS-A is used.

If the target system includes an external clock, select either (1) Clock that is already mounted on emulation board, (2) Clock that is mounted by user, or (3) Pulse input from target system.

For the external clock, a clock signal is supplied from outside of the target device and the target device's internal oscillator is not used. An example of the external circuit is shown in part (b) of Figure 3-3.

Caution The IE system will be hung-up if the main system clock is not supplied normally. Moreover, be sure to input a rectangular wave as the pulse from the target system. There is no need to supply a clock to the X2 and XT2 pins. Also, even if a crystal resonator is connected directly to X1 (for the main system clock) or XT1 (for the subsystem clock), the target device will not operate.

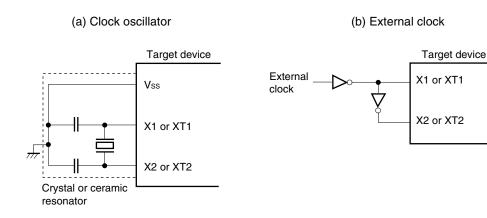


Figure 3-3. External Circuits Used as System Clock Oscillator

*

(1) Clock that is already mounted on emulation board

The crystal oscillator mounted on the IE-789831-NS-EM1 can be used.

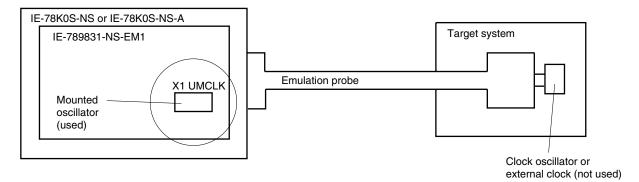
(a) Main system clock

*

*

A crystal oscillator (X1 UMCLK) is already mounted on the emulation board. Its frequency is 3.58 MHz.

Figure 3-4. When Using Clock That Is Already Mounted on Emulation Board (Main System Clock)

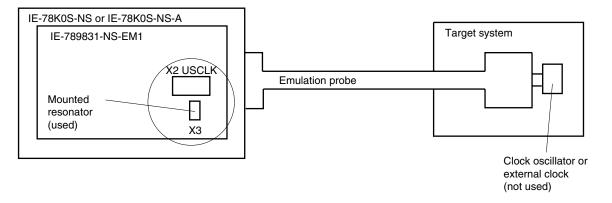


Remark The clock that is supplied by the oscillator of the IE-789831-NS-EM1 (encircled in the figure) is used.

(b) Subsystem clock

A crystal resonator (X3) is already mounted on the emulation board. Its frequency is 32.768 kHz

Figure 3-5. When Using Clock That Is Already Mounted on Emulation Board (Subsystem Clock)



Remark The clock that is supplied by the resonator of the IE-789831-NS-EM1 (encircled in the figure) is used.

(2) Clock that is mounted by user

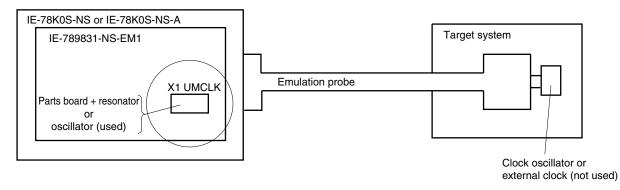
The user can mount any clock supported by the set specifications on the IE-789831-NS-EM1. This feature is effective when debugging at a different frequency than the clock already mounted.

(a) Main system clock

Remove the crystal oscillator (X1 UMCLK) that is already mounted on the emulation board, and mount the parts board on which the resonator to be used is mounted or mount the oscillator to be used.

★





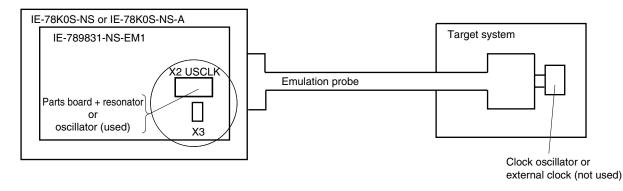
Remark The clock that is supplied by the resonator of the IE-789831-NS-EM1 (encircled in the figure) or the oscillator is used.

(b) Subsystem clock

Remove the parts board (X2 USCLK) that is already mounted on the emulation board, and mount the parts board on which the resonator to be used is mounted or mount the oscillator to be used.

*



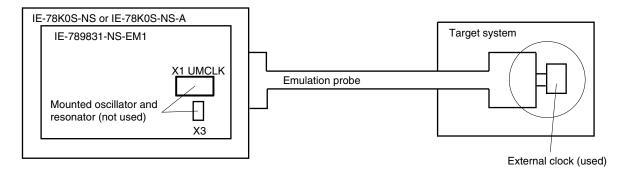


Remark The clock that is supplied by the resonator of the IE-789831-NS-EM1 (encircled in the figure) or the oscillator is used.

(3) Pulse input from target system

An external clock on the target system can be used as both the main system clock and subsystem clock via an emulation probe.

Figure 3-8. When Supplying Pulse from Target System



Remark The pulse that is supplied by the external clock on the target system (encircled in the figure) or the oscillator is used.

3.4.2 Main system clock settings

Table 3-4 shows the settings of the IE-789831-NS-EM1 when the main system clocks in (1) to (3) are used.

Table 3-4. Main System Clock Settings

Frequency of Main System Clock		IE-789831-NS-EM1	CPU Clock Source
		X1 UMCLK	Selection (ID78K0S-NS)
(1) When using clock that is already mounted on emulation board	3.58 MHz	Oscillator	Internal
(2) When using clock mounted by user	Other than 3.58 MHz	Oscillator configured by user	
(3) When inputting pulse from target system		Oscillator (not used)	External

- Caution When inputting a pulse from the target system, open the configuration dialog box when starting the integrated debugger (ID78K0S-NS) and select "External" in the area (Clock) for selecting the CPU's clock source (this selects the user's clock).
- **Remark** The factory settings of the IE-789831-NS-EM1 are those listed above under "when using clock that is already mounted on emulation board".

(1) When using clock that is already mounted on emulation board

When the IE-789831-NS-EM1 is shipped, a 3.58 MHz crystal oscillator is already mounted in the IE-789831-NS-EM1's socket (X1 UMCLK). When using the factory-set mode settings, there is no need to make any other hardware settings.

When starting the integrated debugger (ID78K0S-NS), open the configuration dialog box and select "Internal" in the area (Clock) for selecting the CPU's clock source (this selects the emulator's internal clock).

(2) When using clock mounted by user

Perform the settings described under either (a) or (b), depending on the type of clock to be used. When starting the integrated debugger (ID78K0S-NS), open the configuration dialog box and select "Internal" in the area (Clock) for selecting the CPU's clock source (this selects the emulator's internal clock).

(a) When using a ceramic resonator or crystal resonator

- Items to be prepared
 - · Parts board
 - Ceramic resonator or crystal resonator
 - Resistor Rx

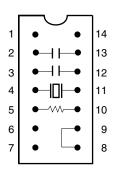
- Capacitor CA
- Capacitor CB
- Solder kit

<Steps>

<1> Solder the target ceramic resonator or crystal resonator, resistor Rx, capacitor CA, and capacitor CB (all with suitable oscillation frequencies) onto the parts board (as shown below).

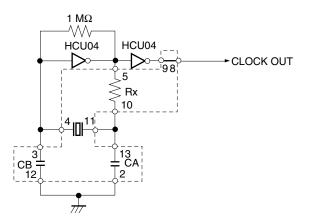
Figure 3-9. Connections on Parts Board (Main System Clock)

Parts board (X1 UMCLK)



Pin No.	Connection	
2-13	Capacitor CA	
3-12	Capacitor CB	
4-11	Ceramic resonator or crystal resonator	
5-10	Resistor Rx	
8-9	Shorted	

Circuit diagram



Remark The sections enclosed in broken lines indicate parts that are attached to the parts board.

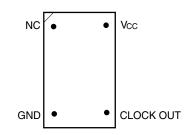
- <2> Prepare the IE-789831-NS-EM1.
- <3> Remove the crystal oscillator that is mounted in the IE-789831-NS-EM1's socket (X1 UMCLK).
- <4> Connect the parts board (from <1> above) to the socket (X1 UMCLK) from which the crystal oscillator was removed. Check the pin 1 mark to make sure the board is mounted in the correct direction.
- <5> Make sure that the parts board is wired as shown in Figure 3-9 above.
- <6> Install the IE-789831-NS-EM1 in the IE-78K0S-NS or IE-78K0S-NS-A.

The above steps configure the following circuit and enable supply of the clock from the mounted resonator to the emulation device.

(b) When using a crystal oscillator

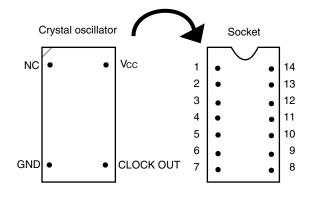
- Items to be prepared
 - Crystal oscillator (see pinouts shown in Figure 3-10)





<Steps>

- <1> Prepare the IE-789831-NS-EM1.
- <2> Remove the crystal oscillator that is mounted in the IE-789831-NS-EM1's socket (X1 UMCLK).
- <3> Connect a crystal oscillator to the socket (X1 UMCLK) from which the crystal oscillator was removed (in <2> above). Insert the pins of the crystal oscillator into the socket aligning the pins as shown in the figure below.



Crystal Oscillator Pin Name	Socket Pin No.
NC	1
GND	7
CLOCK OUT	8
Vcc	14

Figure 3-11. Pin Alignment of Crystal Oscillator and Socket (Main System Clock)

<4> Install the IE-789831-NS-EM1 in the IE-78K0S-NS or IE-78K0S-NS-A.

(3) When inputting pulse from target system

No hardware settings are required for this situation.

When starting the integrated debugger (ID78K0S-NS), open the configuration dialog box and select "External" in the area (Clock) for selecting the CPU's clock source (this selects the user's clock).

3.4.3 Subsystem clock setting

Table 3-5 shows the settings of the IE-789831-NS-EM1 when the subsystem clocks in (1) to (3) are used.

Encourse of Outer story	IE-789831-NS-EM1		
Frequency of Subsystem 0	X2 USCLK	JP1	
(1) When using clock (X3) that is already mounted on emulation board	32.768 kHz	6 and 8 shorted	2 and 3 shorted
(2) When using clock mounted by user	Other than 32.768 kHz	Oscillator configured by user	
(3) When inputting pulse from target system		Not used	1 and 2 shorted

Table 3-5. Subsystem Clock Settings

Caution Before setting JP1 to switch between the clock on the board and external clock, turn off the power of the IE-78K0S-NS or IE-78K0S-NS-A.

Remark The factory settings of the IE-789831-NS-EM1 are those listed above under "when using clock that is already mounted on emulation board".

(1) When using clock that is already mounted on emulation board

When the IE-789831-NS-EM1 is shipped, a 32.768 kHz crystal resonator (X3) and a parts board (X2 USCLK) on which pins 6 and 8 are shorted are already mounted on the IE-789831-NS-EM1. Short 2 and 3 of the jumper (JP1) on the IE-789831-NS-EM1. No settings are required on the integrated debugger (ID78K0S-NS).

(2) When using clock mounted by user

Perform the settings in (a) or (b) below, depending on the type of clock to be used. Short 2 and 3 of the jumper (JP1) on the IE-789831-NS-EM1.

No settings are required on the integrated debugger (ID78K0S-NS).

(a) When using a ceramic resonator or crystal resonator

- Items to be prepared
 - Ceramic resonator or crystal resonator
 - Resistor Rx
 - Capacitor CA

<Steps>

<1> Prepare the IE-789831-NS-EM1.

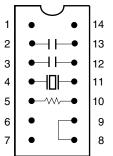
<2> Solder the target ceramic resonator or crystal resonator, resistor Rx, capacitor CA, and capacitor CB (all with suitable oscillation frequencies) onto the parts board (X2 USCLK).

Capacitor CB

Solder kit

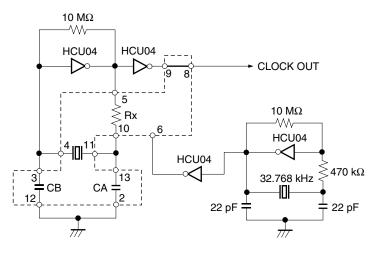
Figure 3-12. Connections on Parts Board (Subsystem Clock)

Parts board (X2 USCLK)



Pin No.	Connection	
2-13	Capacitor CA	
3-12	Capacitor CB	
4-11	Ceramic resonator or crystal resonator	
5-10	Resistor Rx	
8-9	Shorted	

Circuit Diagram



Remark The sections enclosed in broken lines indicate parts that are attached to the parts board.

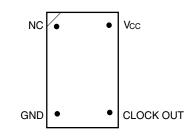
<3> Make sure that the parts board (X2 USCLK) is wired as shown in Figure 3-12 above.

<4> Install the IE-789831-NS-EM1 in the IE-78K0S-NS or IE-78K0S-NS-A.

(b) When using a crystal oscillator

- Items to be prepared
 - Crystal oscillator (see pinouts shown in Figure 3-13)

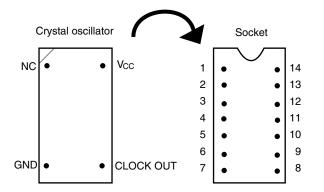
Figure 3-13. Crystal Oscillator (Subsystem Clock)



<Steps>

- <1> Prepare the IE-789831-NS-EM1.
- <2> Remove the parts board that is mounted in the socket (X2 USCLK) of the IE-789831-NS-EM1.
- <3> Connect a crystal oscillator to the socket (X2 USCLK) from which the parts board was removed (in <2> above). Insert the crystal oscillator into the socket aligning the pins as shown in the figure below.

Figure 3-14. Pin Alignment of Crystal Oscillator and Socket (Subsystem Clock)



Crystal Oscillator Pin Name	Socket Pin No.
NC	1
GND	7
CLOCK OUT	8
Vcc	14

<4> Install the IE-789831-NS-EM1 in the IE-78K0S-NS or IE-78K0S-NS-A.

(3) When inputting pulse from target system

Short 1 and 2 of the jumper (JP1) on the IE-789831-NS-EM1. No settings are required on the integrated debugger (ID78K0S-NS).

3.5 External Trigger

To set an external trigger, connect the IE-789831-NS-EM1's check pins EXTOUT and EXTIN as shown below. See the **IE-78K0S-NS User's Manual (U13549E)** or **IE-78K0S-NS-A User's Manual (U15207E)** for pin characteristics.

For the use methods, see the ID78K Series Ver.2.30 or Later Operation Windows Based User's Manual (U15185E).

(1) EXTOUT

The EXTOUT pin on the IE-789831-NS-EM1 outputs a low level for 1.3 μ s when a break event occurs.

Caution Connect a pull-up resistor on the target system because this is an open drain output.

(2) EXTIN

An event signal can be input from the EXTIN pin on the IE-789831-NS-EM1. Input a high-level pulse signal for 2 CPU operation clocks or more.

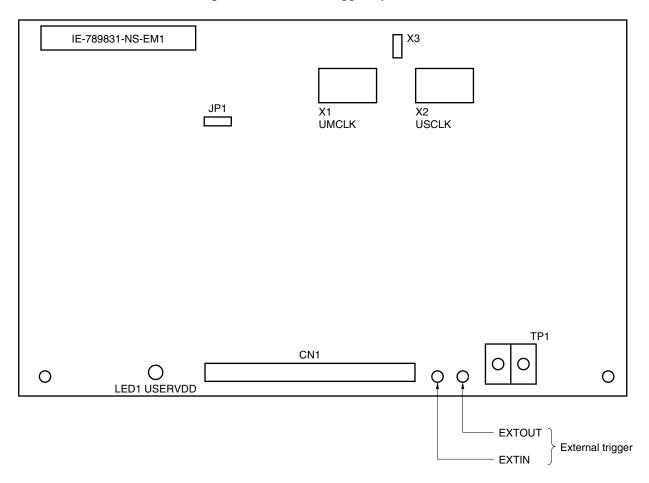


Figure 3-15. External Trigger Input Position

CHAPTER 4 DIFFERENCES BETWEEN TARGET DEVICE AND TARGET INTERFACE CIRCUIT

This chapter describes differences between the target device's signal lines and the signal lines of the target interface circuit of the IE system.

The target interface circuit of the IE system realizes emulation via an emulation circuit configured by an emulation CPU, TTL, CMOS-IC, and other components. The electrical characteristics are different from those of the target device because a protector and other circuits are provided.

- (1) Signals input to or output from the emulation CPU
- (2) Signals input from the target system via a gate
- (3) LCD-related signals
- (4) Other signals

The IE-789831-NS-EM1's circuit is used as follows for signals listed in (1) to (4) above.

(1) Signals input to or output from the emulation CPU

The following signals perform the same operations as in the μ PD789830 and the μ PD78F9831. However, a 1 Ω pull-down resistor and 100 Ω resistor are inserted in series.

- Signals related to port 0
- Signals related to port 1
- Signals related to port 2
- Signals related to port 3
- Signals related to port 4

(2) Signals input from the target system via a gate

Since the following signals are input via a gate, their timing shows a delay compared to the μ PD789830 and the μ PD78F9831. Their AC characteristics and DC characteristics are therefore different from the μ PD789830 and the μ PD78F9831 making it necessary to observe a stricter timing design than in the μ PD789830 and the μ PD78F9831.

- RESET signal
- Signals related to clock input

In all the signals input from the target system, the RESET signal and signals related to clock input are input to the emulation CPU via a logic IC. The DC characteristics are therefore different from the μ PD789830 and the μ PD78F9831.

(3) LCD-related signals

Because the following signals input/output LCD-related signals, special processing is not performed in the IE-789831-NS-EM1.

- Common pins (COM0 to COM15)
- Segment pins (S0 to S31)
- Port 5 (alternately functions as P50 to P57/S32 to S39)

(4) Other signals

• VDD pin

When the emulation CPU is operating at 5 V, its power is supplied from the IE-789831-NS-EM1, but when operating at low voltage, its power is supplied from the low-voltage pin (TP1). The V_{DD} pin of the target system is only used to control the LED (TV_{CC}) in the IE-789831-NS-EM1 that monitors the input of the target system's power supply.

• Vss pin

The Vss pin is connected to GND in the IE-789831-NS-EM1

• TEST/VPP pin

The TEST/VPP pin is not used in the IE-789831-NS-EM1.

• X2, XT2 pins

The X2 and XT2 pins are not used in the IE-789831-NS-EM1.

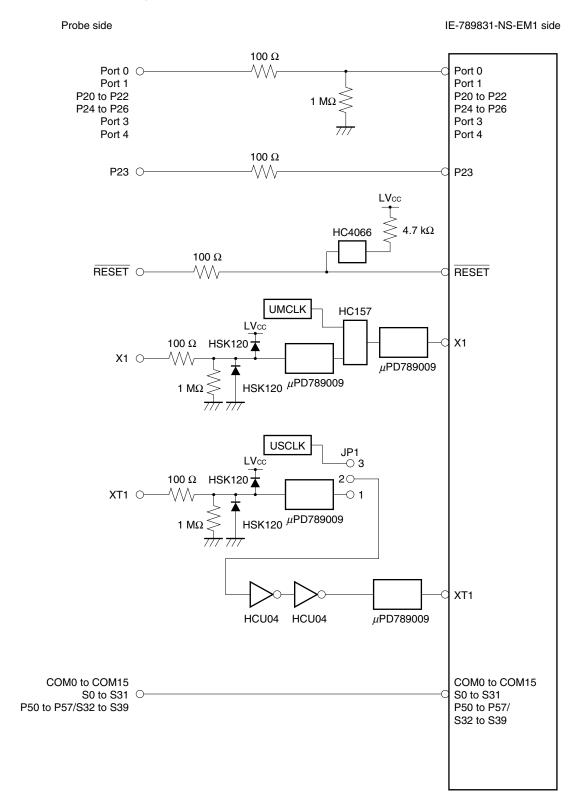
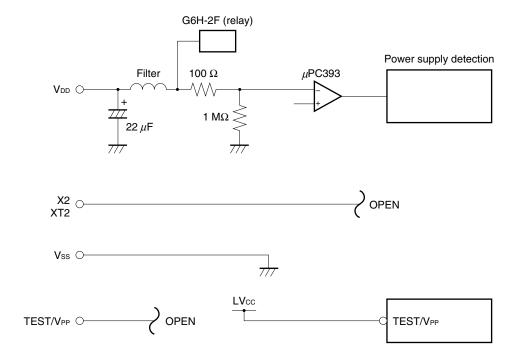


Figure 4-1. Equivalent Circuit of Emulation Circuit (1/2)

Figure 4-1. Equivalent Circuit of Emulation Circuit (2/2)

Probe side

IE-789831-NS-EM1 side



APPENDIX A EMULATION PROBE PIN ASSIGNMENT TABLE

Emulation Probe	CN1 Pin No.	Emulation Probe	CN1 Pin No.
1	118	35	57
2	117	36	58
3	114	37	59
4	113	38	60
5	108	39	55
6	107	40	56
7	104	41	49
8	103	42	50
9	100	43	45
10	99	44	46
11	94	45	41
12	93	46	42
13	30	47	35
14	29	48	36
15	24	49	31
16	23	50	32
17	20	51	4
18	19	52	3
19	16	53	8
20	15	54	7
21	10	55	14
22	9	56	13
23	6	57	18
24	5	58	17
25	33	59	22
26	34	60	21
27	37	61	28
28	38	62	27
29	43	63	92
30	44	64	91
31	47	65	98
32	48	66	97
33	51	67	102
34	52	68	101

Table A-1. NP-100GC, NP-H100GC-TQ Pin Assignments (1/2)

Remarks 1. NP-100GC and NP-H100GC-TQ are products of Naito Densei Machida Mfg. Co., Ltd.

^{2.} The numbers in the "Emulation probe" column indicate the corresponding pin number on the emulation probe tip.

Emulation Probe	CN1 Pin No.	Emulation Probe	CN1 Pin No.
69	106	85	63
70	105	86	64
71	112	87	61
72	111	88	62
73	116	89	65
74	115	90	66
75	87	91	71
76	88	92	72
77	83	93	75
78	84	94	76
79	77	95	79
80	78	96	80
81	73	97	85
82	74	98	86
83	69	99	89
84	70	100	90

Table A-1. NP-100GC, NP-H100GC-TQ Pin Assignments (2/2)

Remarks 1. NP-100GC and NP-H100GC-TQ are products of Naito Densei Machida Mfg. Co., Ltd.

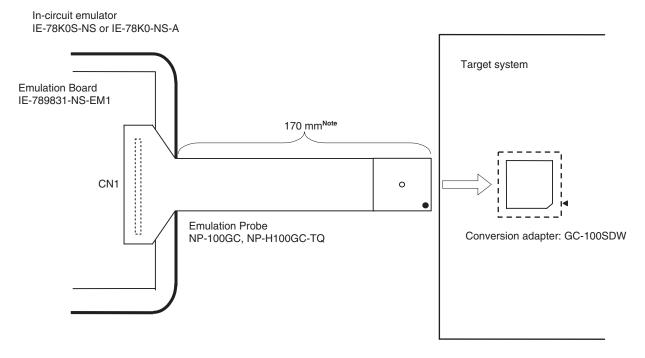
2. The numbers in the "Emulation probe" column indicate the corresponding pin number on the emulation probe tip.

APPENDIX B NOTES ON DESIGNING TARGET SYSTEM

The following shows the conditions when connecting the emulation probe to the conversion adapter. Follow the configuration below and consider the shape of parts to be mounted on the target system when designing a system. Among the products described in this appendix, NP-100GC and NP-H100GC-TQ are products of Naito Densei Machida Mfg. Co., Ltd., and TGC-100SDW is a product of TOKYO ELETECH CORPORATION.

Emulation Probe	Conversion Adapter	Distance Between IE System and Conversion Adapter
NP-100GC	TGC-100SDW	170 mm
NP-H100GC-TQ		370 mm





Note Distance when the NP-100GC is used. When the NP-H100GC-TQ is used, the distance is 370 mm.

*

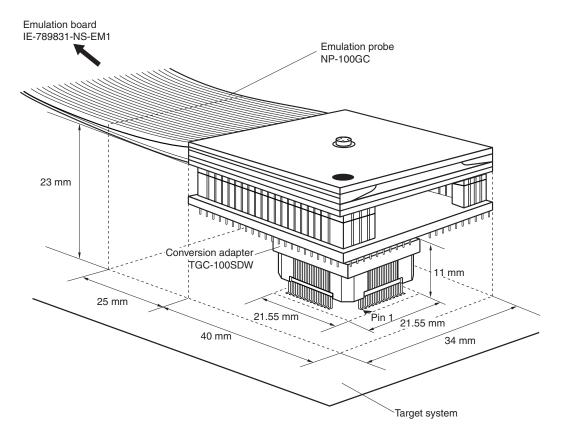


Figure B-2. Connection Conditions of Target System (When NP-100GC Is Used)

Figure B-3. Connection Conditions of Target System (When NP-H100GC-TQ Is Used)

